## mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# XP151A12A2MR-G

Power MOSFET

## ■GENERAL DESCRIPTION

The XP151A12A2MR-G is an N-channel Power MOSFET with low on state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

#### APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

#### ■ FEATURES

Low On-State Resistance :  $Rds(on) = 0.1 \Omega @ Vgs = 4.5V$ :  $Rds(on) = 0.16 \Omega @ Vgs = 2.5V$ Ultra High-Speed Switching Gate Protect Diode Built-in Driving Voltage : 2.5VN-Channel Power MOSFET DMOS Structure Small Package : SOT-23 Environmentally Friendly : EU RoHS Compliant, Pb Free

### ■ PRODUCT NAMES

PRODUCTS	PACKAGE	ORDER UNIT
XP151A12A2MR	SOT-23	3,000/Reel
XP151A12A2MR-G <sup>(*)</sup>	SOT-23	3,000/Reel

<sup>(\*)</sup> The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

## ■ABSOLUTE MAXIMUM RATINGS

		Та	= 25°C
PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	20	V
Gate - Source Voltage	Vgss	±12	V
Drain Current (DC)	ld	1	А
Drain Current (Pulse)	ldp	4	Α
Reverse Drain Current	ldr	1	Α
Channel Power Dissipation *	Pd	0.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

\* When implemented on a ceramic PCB

#### PIN CONFIGURATION/ MARKING



G : Gate S : Source D : Drain

(TOP VIEW) \* x represents production lot number.

### ■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

## ■ ELECTRICAL CHARACTERISTICS

#### DC Characteristics

DC Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	MBOL CONDITIONS		TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= 20V, Vgs= 0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs= $\pm 12V$ , Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	0.7	-	1.4	V
Drain-Source On-State Resistance *1	Rds(on)	ld= 0.5A, Vgs= 4.5V	-	0.075	0.1	Ω
		Id= 0.5A, Vgs= 2.5V	-	0.120	0.160	Ω
Forward Transfer Admittance *1	Yfs	ld= 0.5A, Vds= 10V	-	3.3	-	S
Body Drain Diode Forward Voltage	Vf	lf= 1A, Vgs= 0V	-	0.8	1.1	V

\*1 Effective during pulse test.

#### **Dynamic Characteristics**

•						~ =0 0
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	180	-	pF
Output Capacitance	Coss		-	120	-	pF
Feedback Capacitance	Crss		-	45	-	pF

#### Switching Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id= 0.5A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	50	-	ns
Fall Time	tf		-	45	-	ns

#### **Thermal Characteristics**

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W

Ta =	25°C
------	------

Ta = 25°C





TOIREX 3/5

## TYPICAL PERFOMANCE CHARACTERISTICS (Continued)



Pulse Width:PW (s)

0.1

1

10

100

0.0001 0.0001

0.001

0.01

- 1. The products and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
- 2. We assume no responsibility for any infringement of patents, patent rights, or other rights arising from the use of any information and circuitry in this datasheet .
- 3. Please ensure suitable shipping controls (including fail-safe designs and aging protection) are in force for equipment employing products listed in this datasheet .
- 4. The products in this datasheet are not developed, designed, or approved for use with such equipment whose failure of malfunction can be reasonably expected to directly endanger the life of, or cause significant injury to, the user.
  (e.g. Atomic energy; aerospace; transport; combustion and associated safety equipment thereof.)
- Please use the products listed in this datasheet within the specified ranges.
   Should you wish to use the products under conditions exceeding the specifications, please consult us or our representatives.
- 6. We assume no responsibility for damage or loss due to abnormal use.
- 7. All rights reserved. No part of this datasheet may be copied or reproduced without the prior permission of TOREX SEMICONDUCTOR LTD.

#### TOREX SEMICONDUCTOR LTD.